

TE Internal #: 2227729-1

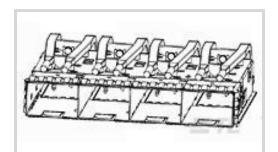
SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 28 Gb/s, Internal/External EMI Springs, EMI Enhanced, With Lightpipe, 1 x 4,

Dual Round, Standard

View on TE.com >



Connectors > Pluggable IO Connectors & Cages > SFP, SFP+ & zSFP+ > zSFP+ Cage Assembly: EMI Springs



Pluggable I/O Product Type: Cage Assembly

Data Rate (Max): 28 Gb/s

EMI Containment Feature Type: Internal/External EMI Springs

Pluggable I/O Applications: EMI Enhanced

Lightpipe Options: With Lightpipe

All zSFP+ Cage Assembly: EMI Springs (25)

Features

Product Type Features

Form Factor	zSFP+
Cage Type	Ganged
Pluggable I/O Product Type	Cage Assembly
Lightpipe Options	With Lightpipe
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Port Matrix Configuration	1 x 4
Lightpipe Configuration	Dual Round
Lightpipe Style	Standard
Lightpipe Profile	Low
Number of Ports	4

Electrical Characteristics

Data Rate (Max)	28 Gb/s	

Termination Features



Termination Method to Printed Circuit Board	Through Hole - Press-Fit
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Mechanical Attachment

Housing Features

Cage Material	Nickel Silver Alloy
Cage Material	TVICKET SILVET / VIOY

Dimensions

PCB Thickness (Recommended)	3 mm[.118 in]
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Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]

Operation/Application

Heat Sink Compatible	No
For Use With Pluggable I/O Products	zSFP+ SMT Connector
Pluggable I/O Applications	EMI Enhanced
Circuit Application	Signal

Packaging Features

Packaging Method	Tray	
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Other

EMI Containment Feature Type Internal/External EMI Springs	
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Product Compliance

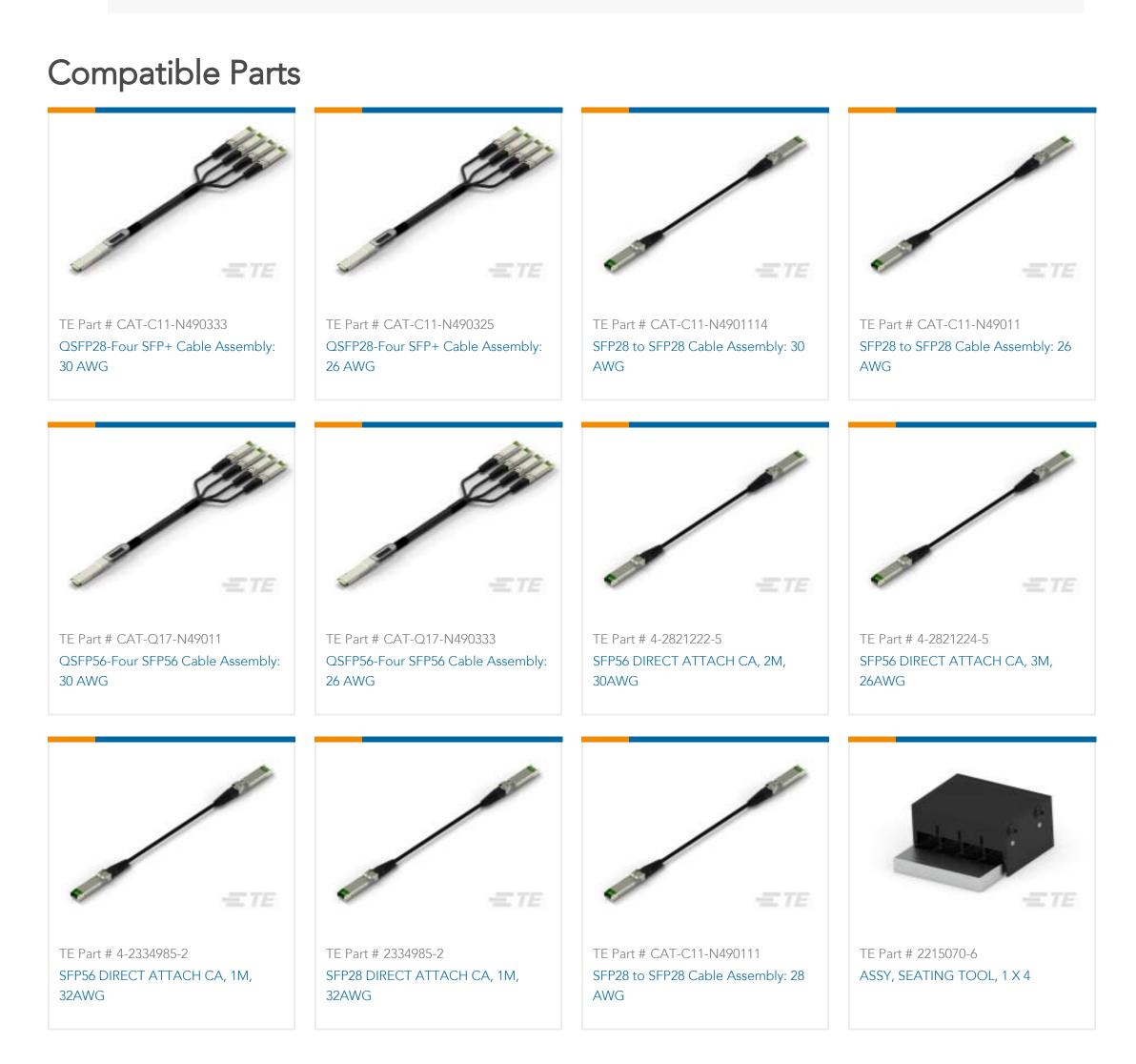
For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer



This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



Customers Also Bought















Documents

Product Drawings

zSFP+ 1x4 Cage Assy, Press-Fit, LP

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2227729-1_B.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2227729-1_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2227729-1_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

zSFP+ Interconnect Brochure

English

Product Specifications

Application Specification

English

Product Environmental Compliance

TE Material Declaration

SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 28 Gb/s, Internal/External EMI Springs, EMI Enhanced, With Lightpipe, 1 x 4, Dual Round, Standard



English

Instruction Sheets

Instruction Sheet (U.S.)

English

Instruction Sheet (U.S.)

English